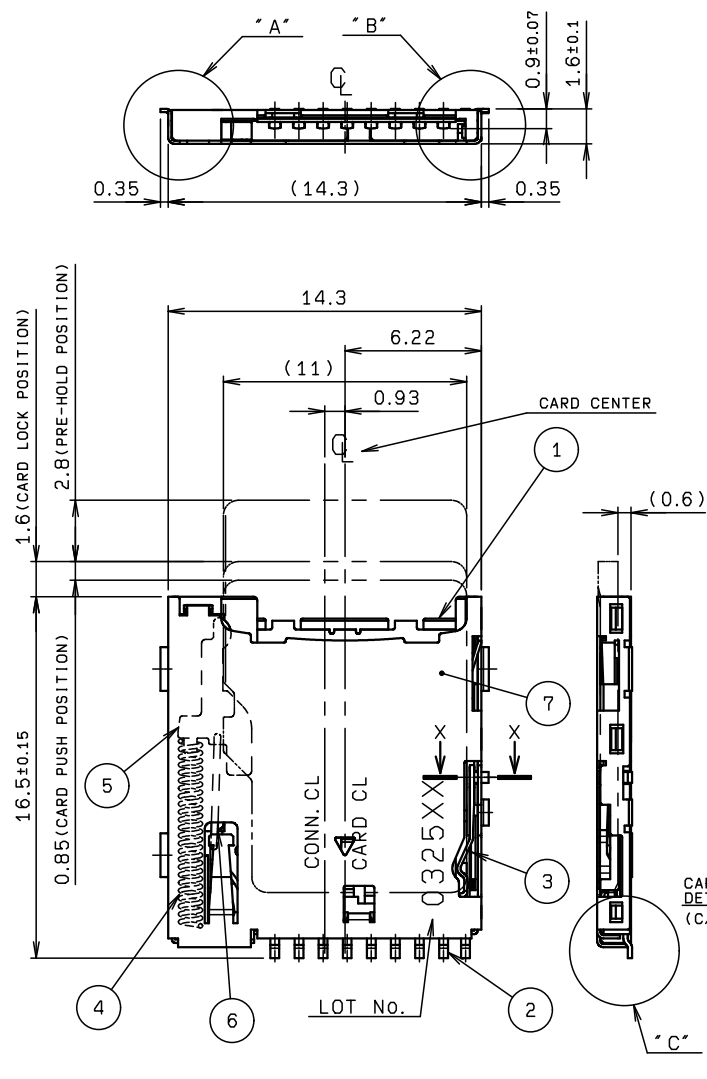
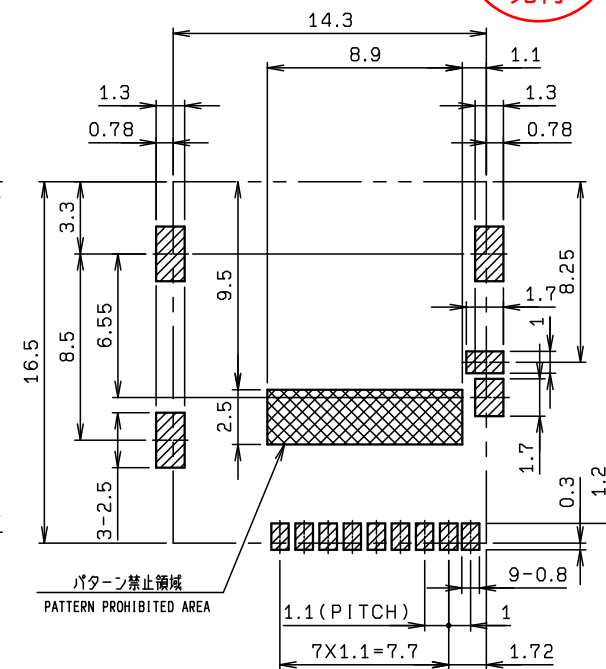
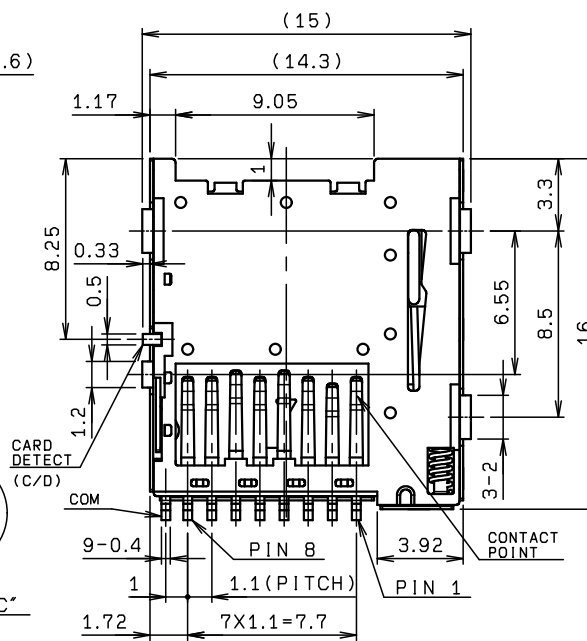


ROHS規制対応
COMPLIANT WITH
ROHS REGULATIONS

NO.	DESCRIPTION	PART NO.	QTY	MATERIAL	DRW NO.	REMARKS
1	INSULATOR		1	LCP		UL94-V0
2	CONTACT		8	PHOS-BRONZE		CONT AREA:AU PLATING TAIL:AU PLATING
3	C/D CONTACT		1	PHOS-BRONZE		CONT AREA:AU PLATING TAIL:AU PLATING
4	COIL SPRING 1		1	SWP		
5	E/J BAR		1	PPS		UL94 V-0
6	CAM BAR		1	SUS		
7	SHIELD PLATE		1	SUS		TAIL:AU PLATING

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RECOMMENDED PCB PATTERN LAYOUT

TOLERANCE / 一般公差 (S)		PRODUCT SPEC / 製品規格					
X <10 ±0.2 10≤ X <30 ±0.25 30≤ X ±0.3		UNIT		ANGLE			
		mm		3RD			
		SCALE		DATE			
ANGLE / 角度		NTS		2011/01/27			
DRAWN		DESIGNED		CHECKED		APPROVED	
H. SADATOKU		S. HORINO				H. SADATOKU	
				DWG NO. / 図番		SHEET/REV	
				BJS 5138025		1/3 A	
				PART NAME / 品名			
				SERIES 5138 Micro-SD ASSY			
				TYPE PUSH/PUSH NORMAL H=1.6			
				PART NO. / 型番			
				04 5138 008 100 858 +			

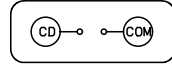
NO.	DESCRIPTION	PART NO.	QTY	MATERIAL	DRW NO.	REMARKS
-----	-------------	----------	-----	----------	---------	---------

注 記
NOTES

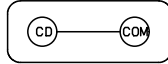
1. テールコプラナリティー: 0.08mmMAX.
COPLANARITY: 0.08mmMAX.

2. 回路構成
CIRCUIT

WITHOUT
CARD

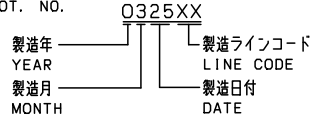


CARD
INSERTED



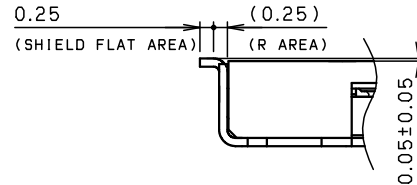
3. 筐体側カードスロット蓋設置の事。CAP FOR THE CARD SLOT
落下衝撃時にカードが飛び出す恐れがある為、筐体側カードスロットに蓋を設置する必要があります。
THE MAIN UNIT SHALL HAVE A CAP FOR THE CARD SLOT IN ORDER TO PREVENT THE CARD FROM POPPING OUT WHEN DROPPING IMPACT IS APPLIED.

4. 製造ロット番号表示
LOT. NO.

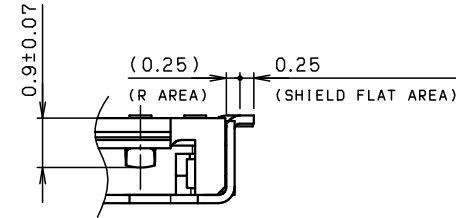


6. めっき仕様・範囲
PLATING (AREA)

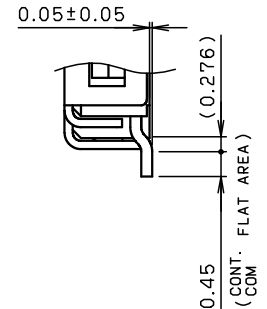
めっき範囲は、めっき加工が最低限実施されていなければならない箇所とする。
THE FOLLOWING SPECIFIED AREAS SHALL BE PLATED FOR SURE.



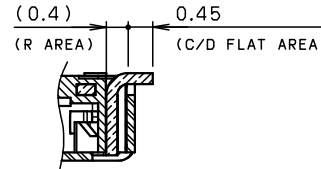
DETAIL "A" (S=10:1)



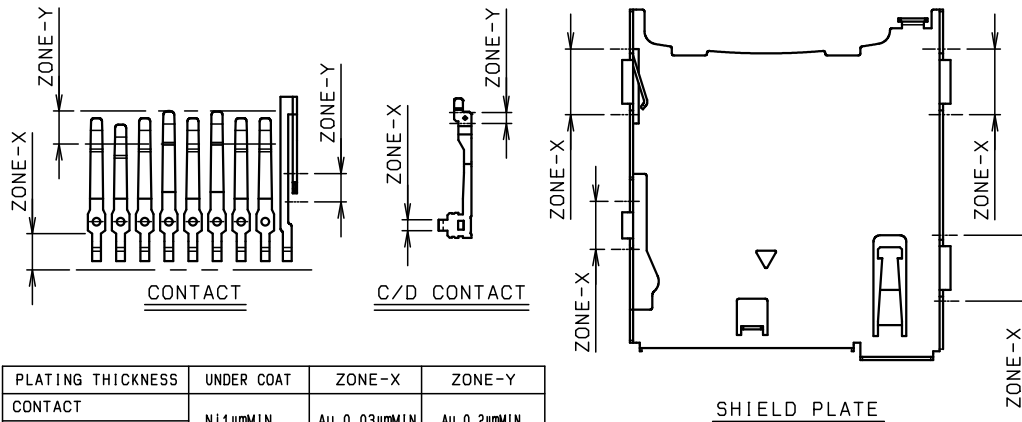
DETAIL "B" (S=10:1)



DETAIL "C" (S=10:1)



SECT. X-X (S=10:1)



PLATING THICKNESS	UNDER COAT	ZONE-X	ZONE-Y
CONTACT	Ni1μmMIN.	Au 0.03μmMIN.	Au 0.2μmMIN.
C/D CONTACT			
SHIELD PLATE	Ni0.5μmMIN.	Au 0.03μmMIN.	

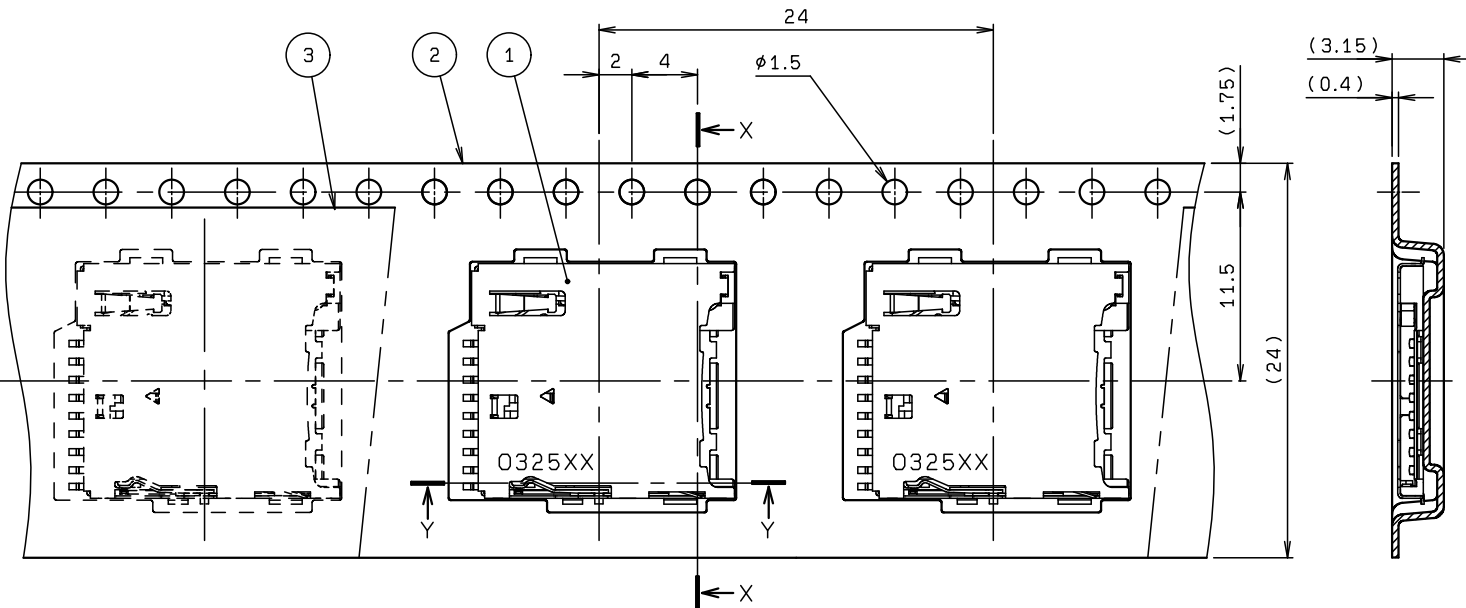
※CONTACT先端部は、テールカットを行っている為、破断面となります。
(先端破断面部へのめっき塗布無し)
THE SURFACE OF CONTACT ENDS ARE RUPTURED (NOT PLATED) BECAUSE TAILS ARE CUT.

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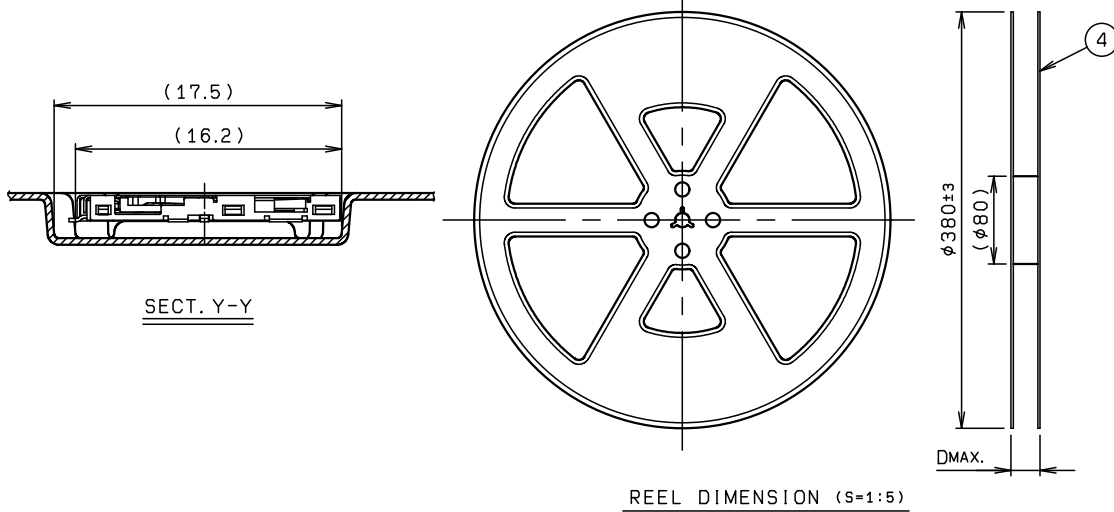
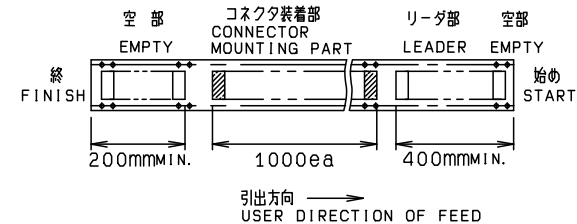
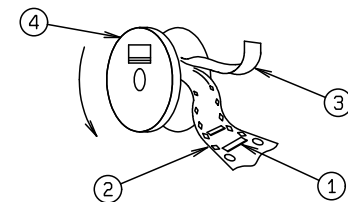
TOLERANCE / 一般公差 (S)		PRODUCT SPEC / 製品規格							
X <10 10 ≤ X <30 30 ≤ X	±0.2 ±0.25 ±0.3								
		UNIT	ANGLE	REFER TO SHEET		1/3			
		mm	3RD	NO.	EDN/DCN	DATE	ISSUE	CHECKED	APPROVED
ANGLE / 角度		SCALE	DATE	PART NAME / 品名					
±3°		NTS	2011/01/27	SERIES 5138 Micro-SD ASSY TYPE PUSH/PUSH NORMAL H=1.6					
DRAWN	DESIGNED	CHECKED	APPROVED	PART NO. / 型番					
H. SADATOKU	S. HORINO		H. SADATOKU	04 5138 008 100 858 +					
KYOCERA				DWG NO. / 図番				SHEET REV	
				BJS 5138025				2/3 A	

NO.	DESCRIPTION	PART NO.	QTY	MATERIAL	DRW NO.	REMARKS
1	CONNECTOR	04 5138 008 100 858 +	1000			
2	EMBOSSED TAPE		1	POLYSTYRENE		
3	TOP COVER TAPE		1	POLYSTYRENE		
4	REEL		1	POLYSTYRENE		



注 記
NOTE

1. 梱包数量 : 1000 個/リール
PACKING QUANTITY : 1000 ea/reel
2. 納入時のリール巻方向
REELING DIRECTION IN DELIVERY
3. 引出し方向
USER DIRECTION OF FEED



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TOLERANCE / 一般公差 (S)		PRODUCT SPEC / 製品規格							
X < 10 ±0.2		UNIT		ANGLE		REFER TO SHEET		1/3	
10 ≤ X < 30 ±0.25		mm		3RD		NO.		EDN/DCN	
30 ≤ X ±0.3		SCALE		DATE		DATE		ISSUE	
ANGLE / 角度 ±3°		NTS		2011/01/27		PART NAME / 品名		CHECKED	
DRAWN H. SADATOKU		DESIGNED S. HORINO		CHECKED		APPROVED H. SADATOKU		PART NO. / 製番	
								04 5138 008 100 858 +	
								DWG NO. / 図番	
								BJS 5138025	
								SHEET/REV	
								3/3 A	